

Device Features

- OIP3 = 31 dBm @ 1900 MHz
- Gain = 19 dB @ 1900 MHz
- Output P1 dB = 17.4 dBm @ 1900 MHz
- 50 Ω Cascadable
- Patented temperature compensation
- RoHS2-compliant SOT-89 SMT package



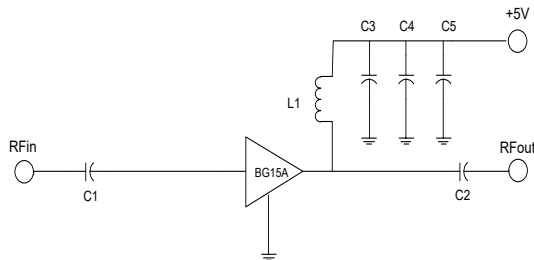
Product Description

BeRex's BG15A is a high performance InGaP/GaAs HBT MMIC amplifier, internally matched to 50 Ohms and uses a patented **temperature compensation** circuit to provide stable current over the operating temperature range without the need for external components. The BG15A is designed for high linearity gain block applications that require excellent gain flatness. It is packaged in a RoHS2-compliant with SOT-89 surface mount package.

Applications

- Base station Infrastructure/RFID
- Commercial/Industrial/Military wireless system

Applications Circuit



- *C1, C2, C3 = 100 pF ± 5%; C4 = 1000 pF ± 5%; C5 = 10uF; L1 = 33nH
- *less than 20nH improves RF performance at over 1.9GHz.
- *40nH or higher value L1 improves RF performance at under 500MHz.
- *Optimum value of L1 may vary with board design.
- *L1:15nH, C1&C2:10pF for 3.5GHz Application.

Typical Performance¹

Parameter	Frequency						Unit
	500	900	1900	2140	2450	3500	
Gain	21.5	21.0	19.0	18.5	18.0	16.6	dB
S11	-15.0	-24.0	-31.0	-30.0	-26.0	-15.8	dB
S22	-16.0	-23.0	-14.0	-12.0	-11.0	-11.8	dB
OIP3 ²	33.0	32.5	31.0	30.5	29.5	28.0	dBm
P1dB	18.3	17.8	17.4	17.1	16.7	15.3	dBm
N. F	2.9	2.9	2.9	2.9	3.1	3.3	dB

¹ Device performance _ measured on a BeRex evaluation board at 25°C, 50 Ω system.

² OIP3 _ measured with two tones at an output of 2 dBm per tone separated by 1 MHz.

Recommended Operating Conditions

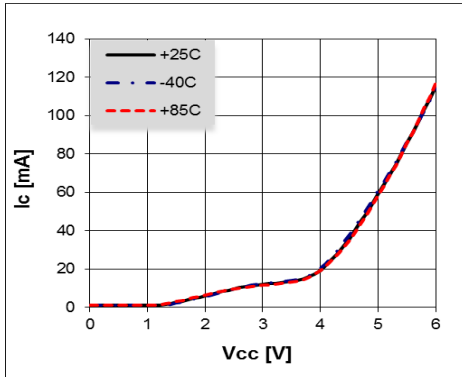
Parameter	Min.	Typical	Max.	Unit
Bandwidth	50		4000	MHz
I _c @ (V _c = 5V)	45	55	65	mA
V _c	4.5	5.0	5.5	V
dG/dT		-0.004		dB/°C
R _{TH}		50		°C/W

Absolute Maximum Ratings

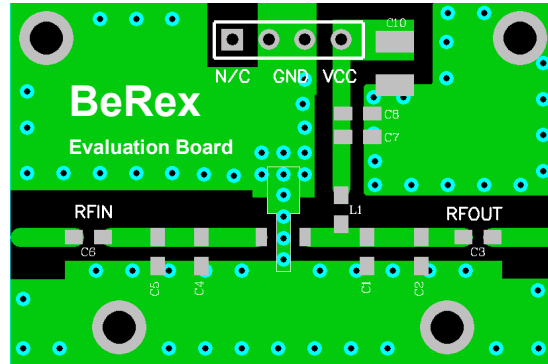
Parameter	Rating	Unit
Operating Case Temperature	-40 to +85	°C
Storage Temperature	-55 to +155	°C
Junction Temperature	+165	°C
Supply Voltage	+6.0	V
Supply Current	150	mA
Input RF Power	23	dBm

Operation of this device above any of these parameters may result in permanent damage.

V-I Characteristics



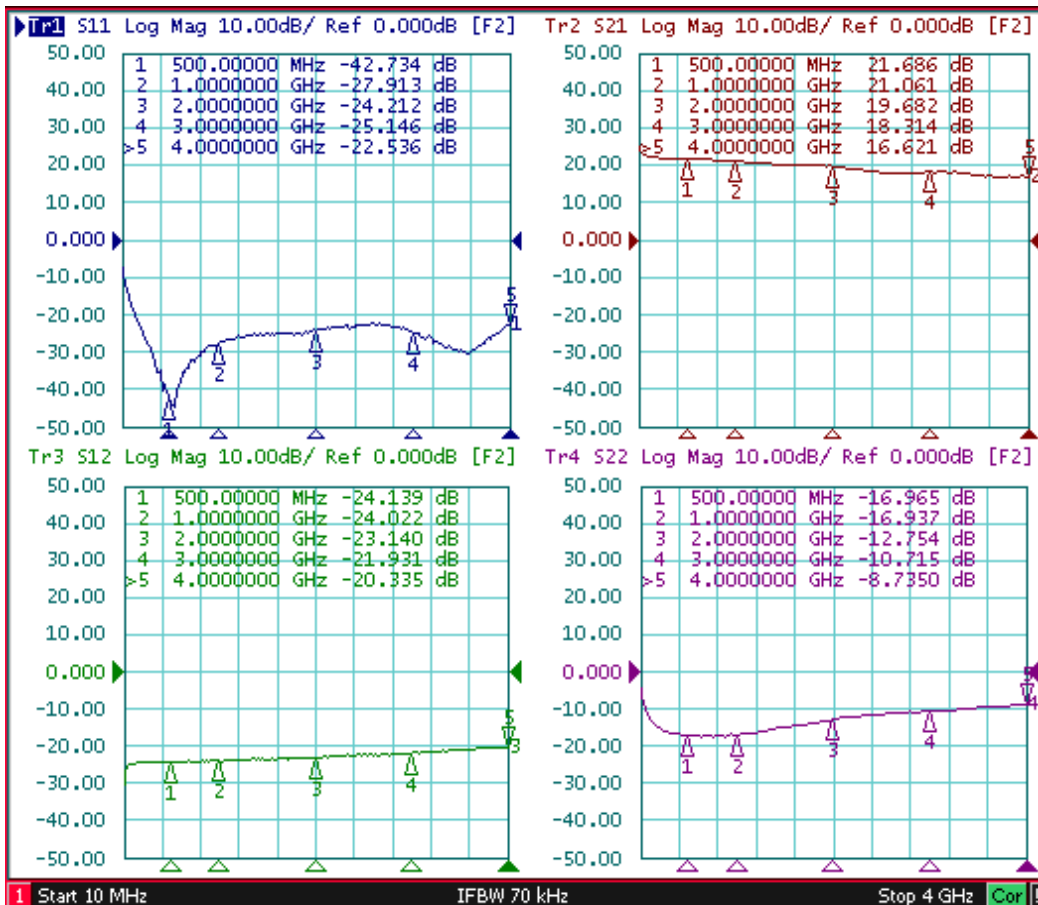
BeRex SOT89 Evaluation Board



*Dielectric constant _ 4.2 *RF pattern width 52mil *31mil thick FR4 PCB

Typical Device Data

S-parameters (Vc=5V, Ic=55mA, T=25°C)



S-Parameter

(V_{device} = 5.0V, I_{cc} = 55mA, T = 25 °C, calibrated to device leads)

Freq [MHz]	S11 Mag	S11 Ang	S21 Mag	S21 Ang	S12 Mag	S12 Ang	S22 Mag	S22 Ang
100	-17.12	-70.67	22.42	166.08	-24.78	10.98	-12.21	-47.15
500	-45.97	-28.59	21.69	152.68	-24.23	3.75	-17.02	-59.37
1000	-27.71	49.94	21.03	129.89	-23.87	4.82	-16.95	-98.65
1500	-25.16	19.40	20.13	109.78	-23.55	4.32	-14.89	-136.56
2000	-24.04	-24.04	19.64	88.33	-22.99	4.25	-12.73	-160.57
2500	-22.67	-66.92	17.89	70.92	-22.44	1.78	-11.45	175.59
3000	-25.21	-88.13	18.32	57.98	-21.89	0.48	-10.68	149.91
3500	-29.79	-48.67	17.33	34.33	-21.04	-3.97	-9.65	120.48
4000	-22.55	3.50	16.65	19.49	-20.36	-8.63	-8.73	89.25

Typical Performance (V_d = 5V, I_c = 55mA, T = 25°C)

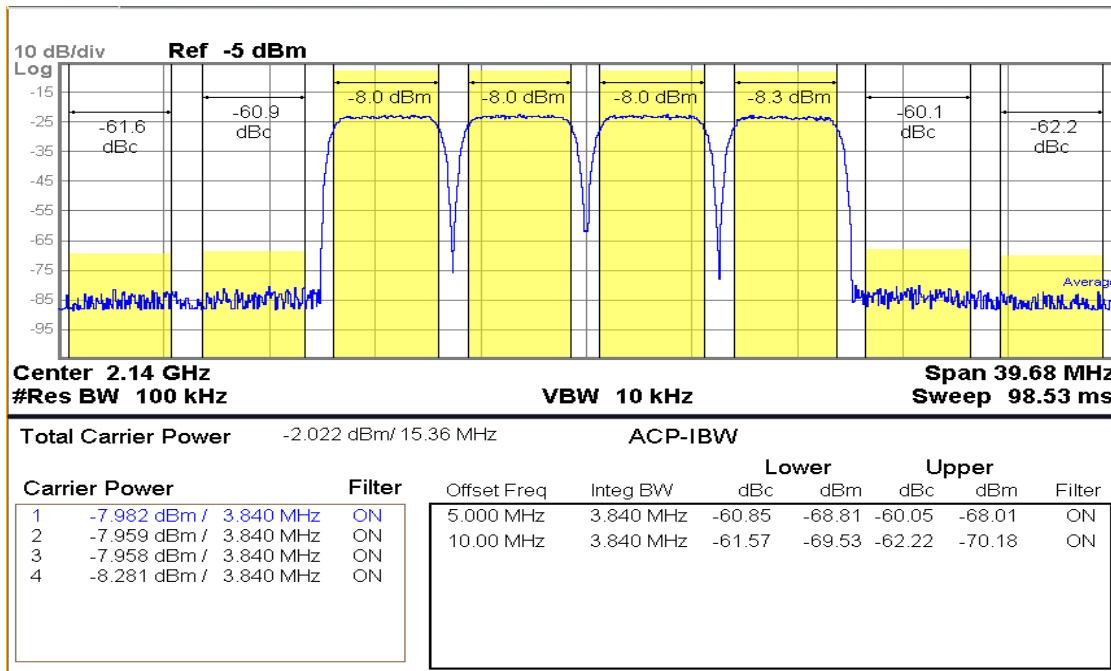
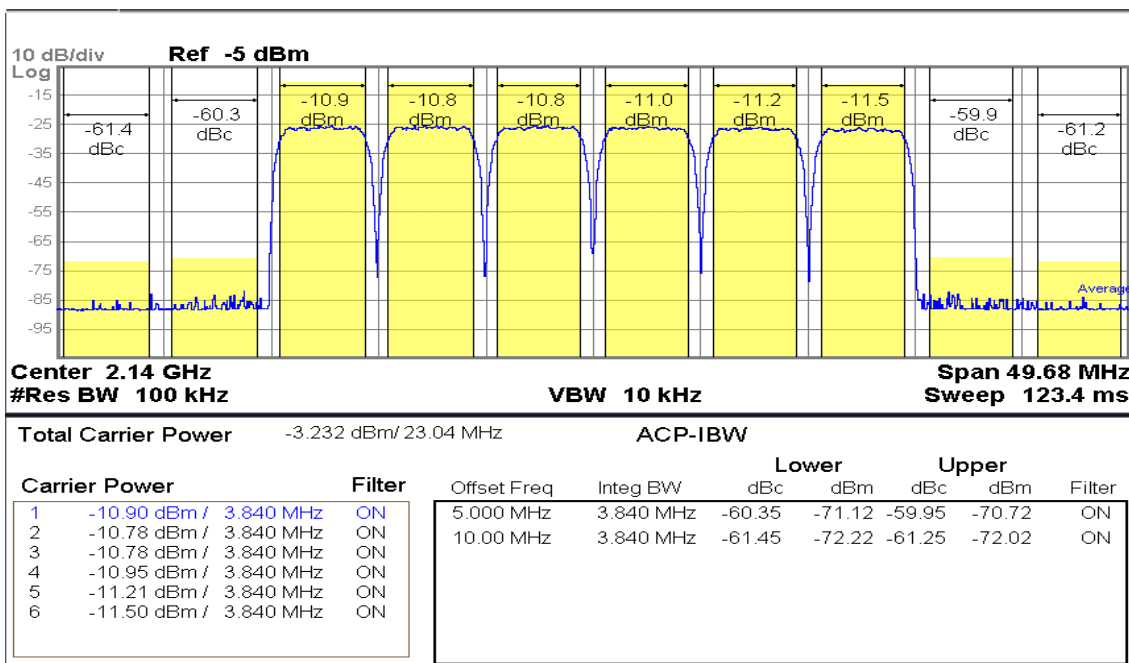
Freq	MHz	70	500	900	1900	2140	2450	3500
S21	dB	23	21.5	21.2	19.2	18.7	18.0	16.6
S11	dB	-11.7	-14.6	-23.9	-32.9	-29.4	-25.3	-15.8
S22	dB	-10.4	-16.1	-23.2	-14.1	-12.5	-11.1	-11.8
P1	dBm	18.7	18.3	17.8	17.4	17.1	16.7	15.3
OIP3	dBm	33	33.2	32.7	31.2	30.5	29.6	28.0
NF	dB	2.8	2.9	2.9	2.9	2.9	3.1	3.3

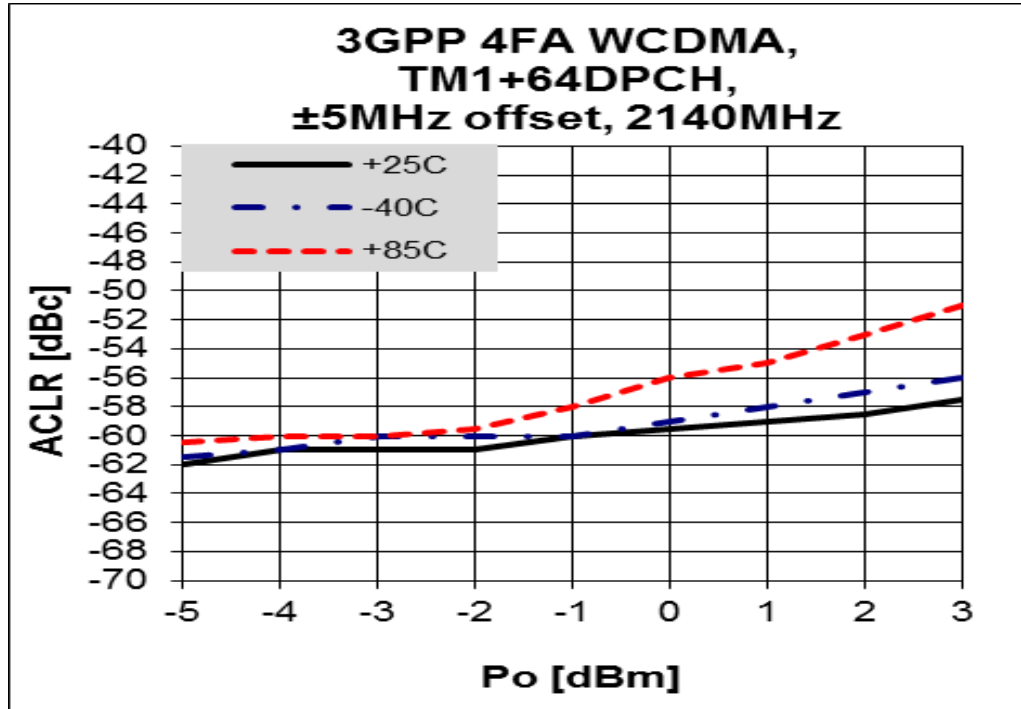
Typical Performance (V_d = 4.7V, I_c = 41mA, T = 25°C)

Freq	MHz	70	500	900	1900	2140	2450
S21	dB	22.6	21.1	20.9	19.0	18.5	17.7
S11	dB	-11.2	-14.0	-22.7	-34.4	-29.4	-25.1
S22	dB	-9.8	-15.3	-20.1	-13.2	-12.0	-10.7
P1	dBm	16.6	16.6	16.1	16.2	16.2	16
OIP3	dBm	28.8	29	28.7	28.5	28.1	27.7
NF	dB	2.7	2.8	2.8	2.8	2.8	3.0

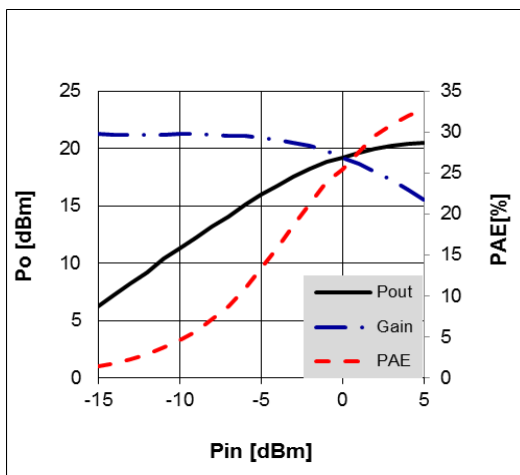
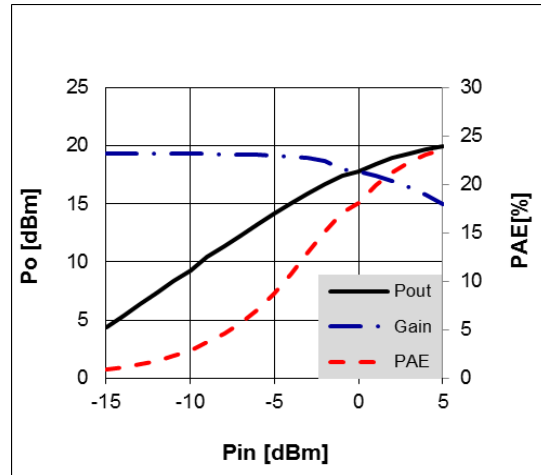
Typical Performance (V_d = 4.5V, I_c = 34mA, T = 25°C)

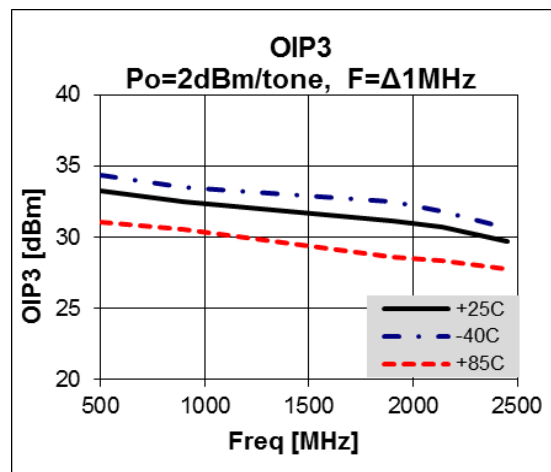
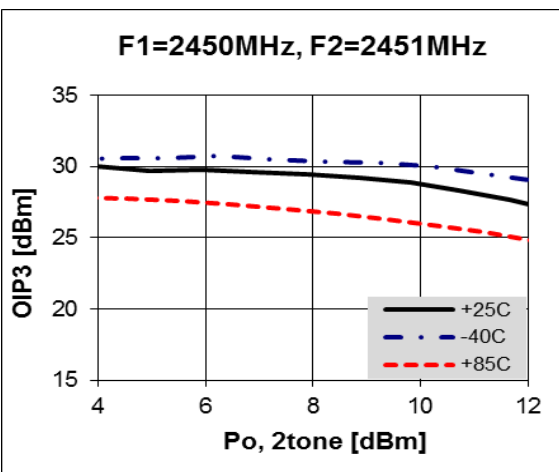
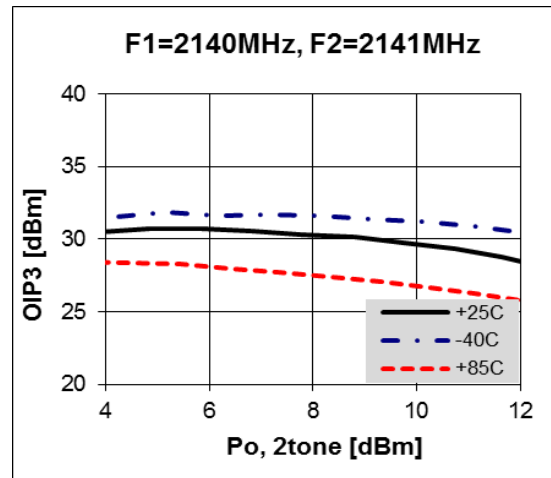
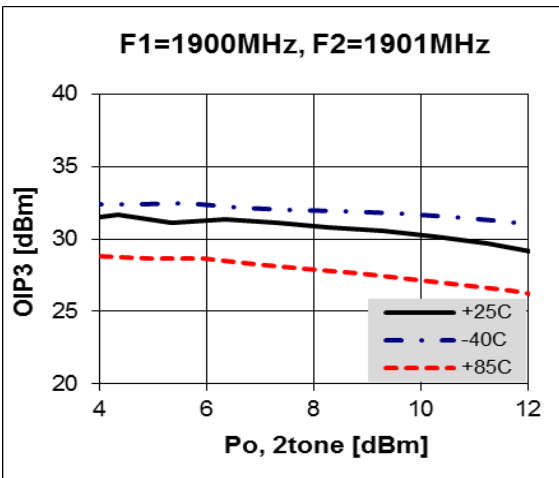
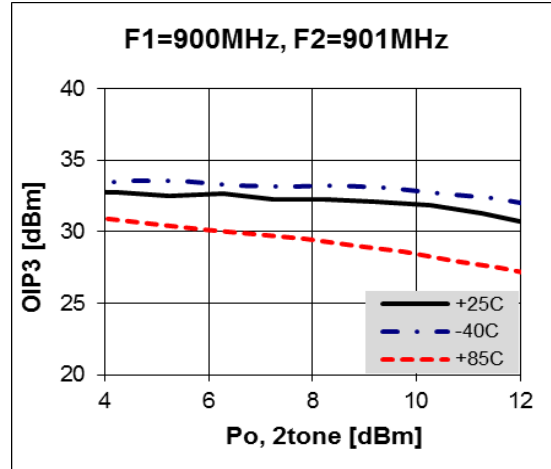
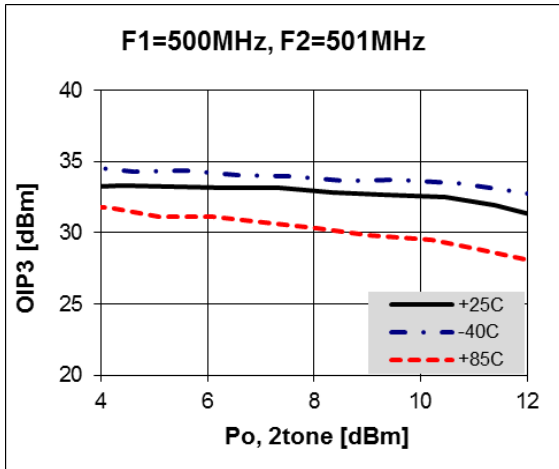
Freq	MHz	70	500	900	1900	2140	2450
S21	dB	22.2	20.7	20.6	18.8	18.3	17.5
S11	dB	-10.6	-13.3	-20.6	-29.8	-26.7	-23
S22	dB	-9.0	-14.2	-17.7	-12.4	-11.2	-10.2
P1	dBm	14.5	14.6	13.9	14.4	14.5	14.8
OIP3	dBm	25.3	25.5	25.1	25.3	25.2	25
NF	dB	2.6	2.8	2.8	2.8	2.8	3.0

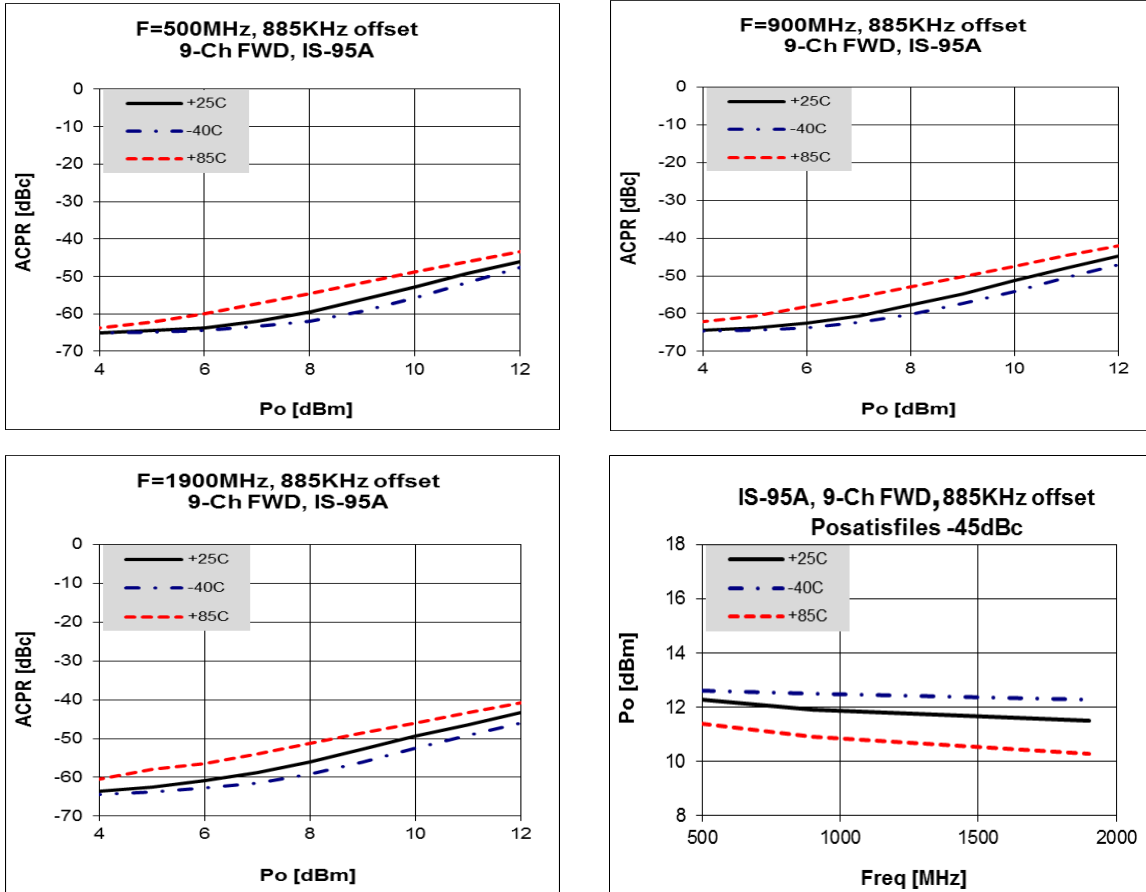
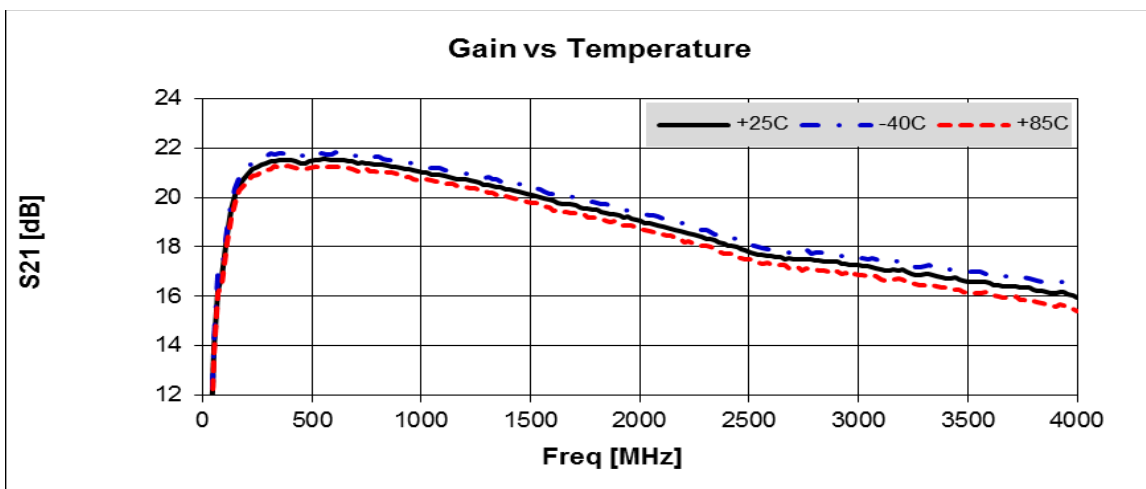
WCDMA 4FA 2140 -60dBc

WCDMA 6FA 2140 -60dBc


ACLR

Device Performance

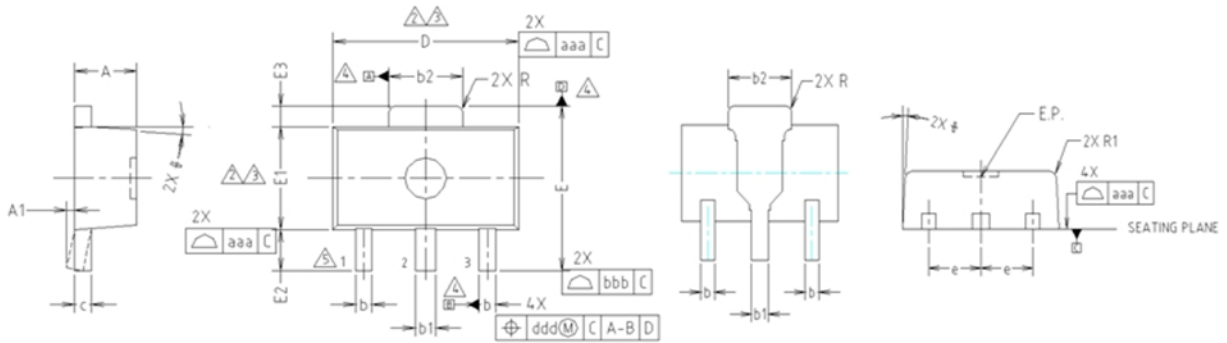
Pin-Pout-Gain


900MHz, 5V/55mA

1900 MHz, 5V/55mA

OIP3


ACPR

Gain Flatness


Package Outline Dimension

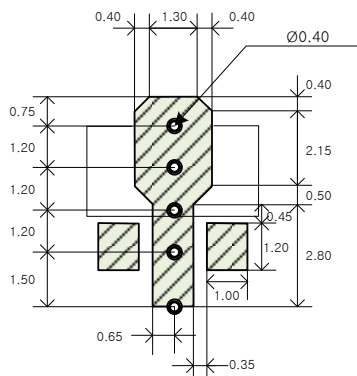


- NOTE:**
 1. DIMENSIONS IN MILLIMETERS.
- ⚠ DIMENSION D DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.5mm PER END. DIMENSION E1 DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.5mm PER SIDE.
 - ⚠ DIMENSIONS D AND E1 ARE DETERMINED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
 - ⚠ DATUMS A, B AND D TO BE DETERMINED 0.18mm FROM THE LEAD TIP.
 - ⚠ TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.

SYMBOL	MILLIMETERS			NOTE
	MINIMUM	NOMINAL	MAXIMUM	
A	1.40	1.50	1.60	
A1	0.00	—	0.10	
b	0.38	0.42	0.48	
b1	0.48	0.52	0.58	
b2	1.79	1.82	1.87	
c	0.40	0.42	0.46	
D	4.40	4.50	4.70	2,3
E	3.70	4.00	4.30	
E1	2.40	2.50	2.70	2,3
E2	0.80	1.00	1.20	
E3	0.40	0.50	0.60	
e	1.50 TYP.			
φ	4° TYP.			
R	0.15 TYP.			
R1	—	—	0.20	
SYMBOL	TOLERANCES OF FORM AND POSITION		NOTE	
aaa	0.15			
bbb	0.20			
ccc	0.10			
ddd	0.10			

Suggested PCB Land Pattern and PAD Layout

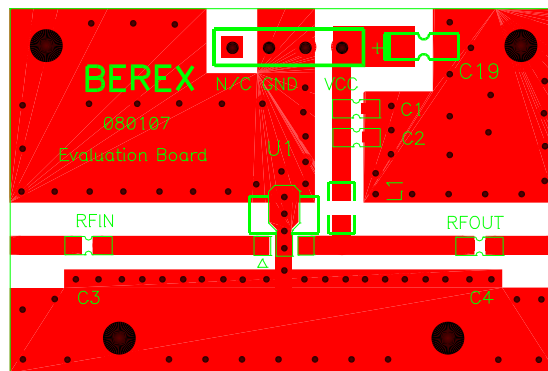
PCB Land Pattern



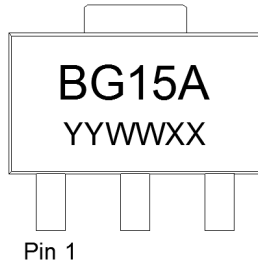
Note : All dimension _ millimeters

PCB lay out _ on BeRex website

PCB Mounting

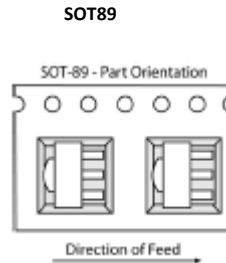


Package Marking



YY = Year, WW = Working Week,
XX = Wafer No.

Tape & Reel



Packaging information:

Tape Width (mm): 12
Reel Size (inches): 7
Device Cavity Pitch (mm): 8
Devices Per Reel: 1000

Lead plating finish

100% Tin Matte finish

(All BeRex products undergoes a 1 hour, 150 degree C, Anneal bake to eliminate thin whisker growth concerns.)

MSL / ESD Rating

ESD Rating: Class 2
Value: Passes <4000V
Test: Human Body Model (HBM)
Standard: JEDEC Standard JESD22-A114

MSL Rating: Level 1 at +265°C convection reflow
Standard: JEDEC Standard J-STD-020



Proper ESD procedures should be followed when handling this device.

NATO CAGE code:

2	N	9	6	F
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